

Data sheet

SAW filter
Short range devices

Series/type: B3743

Ordering code: B39431B3743H110

Date: March 07, 2019

Version: 2.5

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RF360 Europe GmbH
A Qualcomm – TDK Joint Venture

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Table of contents

1 Application	∠
2 Features	_
3 Package.	5
4 Pin configuration	5
5 Matching circuit	
6 <u>Characteristics</u>	7
7 Maximum ratings	8
8 Transmission coefficient	<u> </u>
9 Packing material	10
10 <u>Marking</u>	12
11 Soldering profile	
12 ESD protection of SAW filters	14
13 Annotations.	
14 Cautions and warnings	
15 Important notes.	



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1 Application

- Low-loss RF filter for remote control receivers
- Balanced and unbalanced operation possible

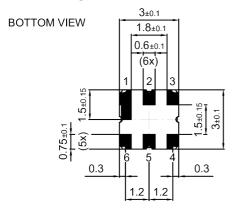
2 Features

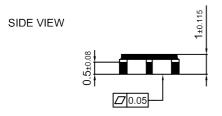
- Package size 3.0±0.1 mm × 3.0±0.1 mm
- Package height 1.0±0.115 mm
- Package code DCC6E
- Approximate weight 0.04 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Lead free soldering compatible with J-STD20C
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 1 (MSL1)
- AEC-Q200 qualified component family (Grade 1: -40 °C to +125 °C)



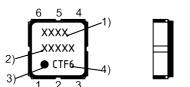
Figure 1: Picture of component with example of product marking.

3 **Package**





TOP VIEW



SIDE VIEW

- 1)Device designation
- 2)Last five digits of the lot number
- 3)Marking for pad number 1
- 4)Example of production location and date code

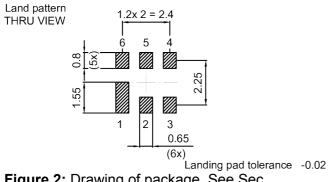


Figure 2: Drawing of package. See Sec.

Package information (p. 16).

Pin configuration

- Input (recommend or ground)
- Output (recommend or ground)
- **2** Ground (recommend or input)
- **3**, 6 Ground
- **5** Ground (recommend or output)

5 Matching circuit

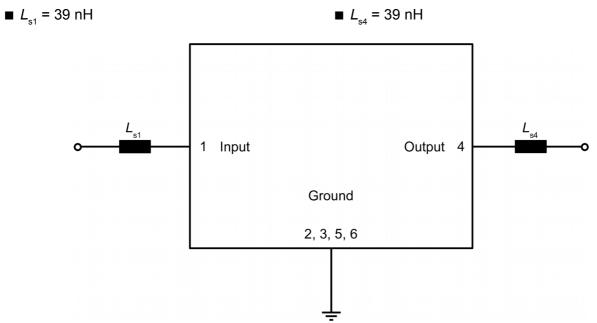


Figure 3: Schematic of matching circuit.



6 Characteristics

Temperature range for specification $T_{\rm SPEC} = -45~{\rm ^{\circ}C}~...~+95~{\rm ^{\circ}C}$ Input terminating impedance $Z_{\rm IN} = 50~\Omega + 39~{\rm nH^{1)}}$ Output terminating impedance $Z_{\rm OUT} = 50~\Omega + 39~{\rm nH^{1)}}$

Characteristics				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Center frequency			f _C	_	433.92	<u> </u>	MHz
Minimum insertion attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
Incl. loss in matching components (Q _L =47)				_	1.9	2.6	dB
Excl. loss in matching components				_	1.5	2.2	dB
Pass band (relative to α_{min})			$\boldsymbol{\alpha}_{\text{rel,max}}$				
	433.75 434.09	MHz		_	0.8	3.0	dB
	433.77 434.07	MHz		_	0.5	2.0	dB
Minimum attenuation (relative to α_{min})			$\boldsymbol{\alpha}_{\text{rel},\text{min}}$				
	10 380	MHz		55	60	_	dB
	380 414	MHz		50	56	_	dB
	414 427	MHz		46	52	<u> </u>	dB
	427 431.52	MHz		24	29	<u> </u>	dB
	431.52 432.9	MHz		15	20	<u> </u>	dB
	432.9 433.1	MHz		13	20	_	dB
	435.1 444.5	MHz		25	30	_	dB
	444.5 450	MHz		40	45	_	dB
	450 810	MHz		47	52	_	dB
	810 1500	MHz		60	65	_	dB
	1500 2500	MHz		50	55	_	dB
Impedance for pass band matching							
@ input port: $Z_{in,iN} = R_{iN} C_{iN}$			$Z_{\text{in,IN}}^{}2)}$	_	350 2.2	_	Ω pF
@ output port: $Z_{in,OUT} = R_{OUT} C_{OUT}$			$Z_{\text{in,OUT}}^{2)}$	_	350 2.2	_	Ω pF

See Sec. Matching circuit (p. 6).

Impedance for pass band matching bases on an ideal, perfect matching of the SAW filter to source and to load impedance (here 50Ω). After removal of the SAW filter the input impedance of the input and output matching network is calculated. The conjugate complex value of these characteristic impedances are the input and output impedances for flat pass band. For more details we refer to RF360 application note #18.



7 Maximum ratings

Operable temperature	T _{OP} = −45 °C +125 °C	
Storage temperature	T _{STG} ¹⁾ = −45 °C +125 °C	
DC voltage	$ V_{DC} = 6.0 \text{ V (max.)}$	
Source power	P _s = 10 dBm	Source impedance 50 Ω.

¹⁾ Not valid for packaging material. Please refer to definition of Shelf life (p. 15).

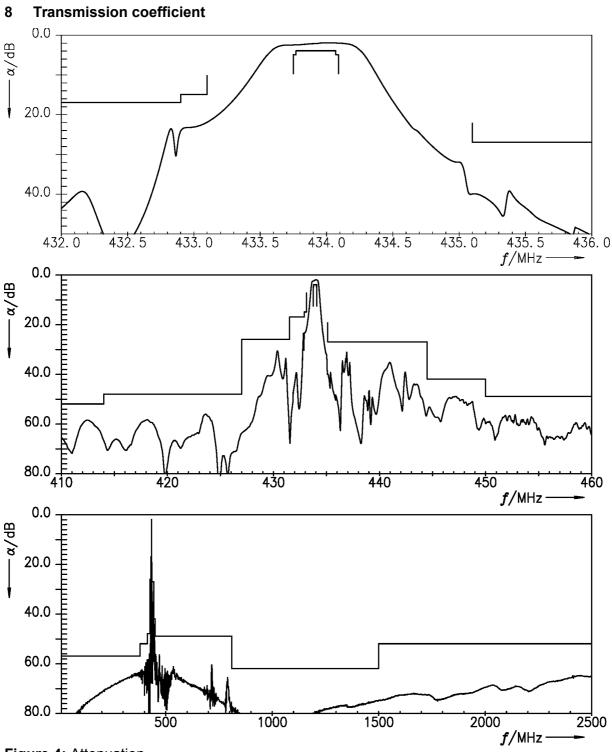


Figure 4: Attenuation .

9 Packing material

9.1 Tape

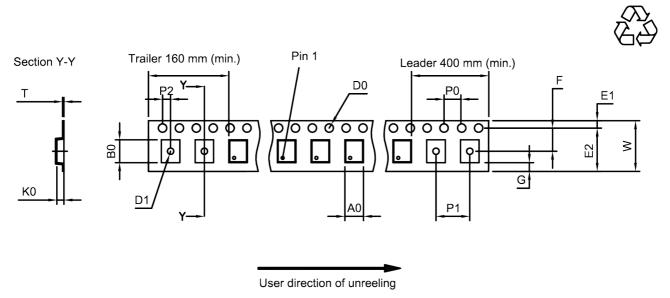


Figure 5: Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

A ₀	3.25 _{±0.1} mm	E ₂	10.25 mm (min.)		P ₁	4.0±0.1 mm
B ₀	3.3±0.1 mm	F	5.5±0.05 mm		P ₂	2.0±0.1 mm
D ₀	1.5+0.1/-0 mm	G	0.75 mm (min.)		Т	0.3±0.05 mm
D_1	1.5 mm (min.)	K_0	1.5±0.1 mm		W	12.0+0.3/-0.1 mm
E ₁	1.75 _{±0.1} mm	P ₀	4.0±0.1 mm	_		

Table 1: Tape dimensions.

9.2 Reel with diameter of 330 mm

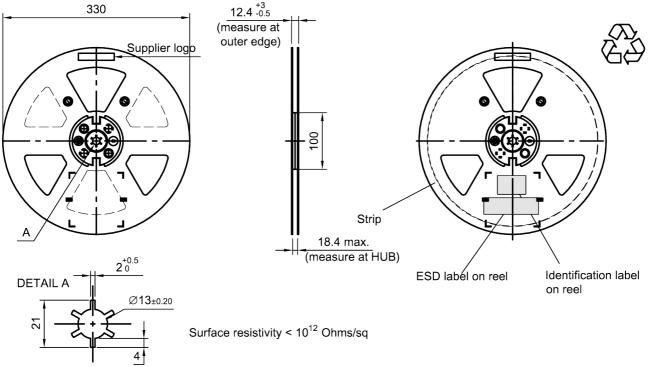


Figure 6: Drawing of reel (first-angle projection) with diameter of 330 mm.

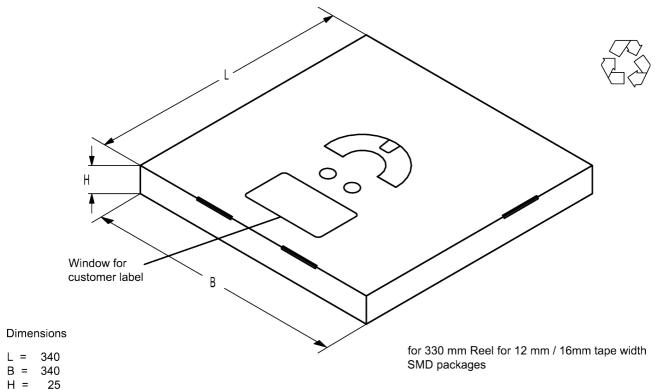


Figure 7: Drawing of folding box for reel with diameter of 330 mm.



10 Marking

Products are marked with device designation, lot number, as well as production location and date code.

■ Device designation: The 4-character device designation of the ordering code is used for the marking.

Example for 4-character device designation: B3xxxxB1234xxxx

■ Lot number: The last 5 digits of the lot number are used for the marking.

Example: <u>12345</u>

■ Production location and date code: The production location is Wuxi (encoded in the first character 'C'). The production date code is encoded in the last three characters according to Table 2.

	1 st digit (day)					2 nd digit (year)			3 rd digit (month)				
Day	Code	Day	Code	Day	Code	Year	Code	Year	Code	Month	Code	Month	Code
1	1	11	Α	21	М	2010	Α	2022	Р	Jan	1	Jul	7
2	2	12	В	22	N	2011	В	2023	R	Feb	2	Aug	8
3	3	13	С	23	Р	2012	С	2024	S	Mar	3	Sep	9
4	4	14	D	24	R	2013	D	2025	Т	Apr	4	Oct	0
5	5	15	Е	25	S	2014	Е	2026	U	May	5	Nov	N
6	6	16	F	26	Т	2015	F	2027	V	Jun	6	Dec	D
7	7	17	Н	27	U	2016	Н	2028	W				
8	8	18	J	28	V	2017	J	2029	Х				
9	9	19	K	29	W	2018	K	2030	Z				
10	0	20	L	30	Х	2019	L	2031	Α				
				31	Z	2020	М	2032	В				
						2021	N	and	so on				

Table 2: Production date code.

Example of how to decode production location and date code:

Code: CTF6

Location: C \rightarrow Wuxi

Day: T \rightarrow 26th

Year: F \rightarrow 2015

Month: 6 \rightarrow June

11 Soldering profile

The recommended soldering process is in accordance with IEC $60068-2-58-3^{rd}$ edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T _{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature <i>T</i>	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

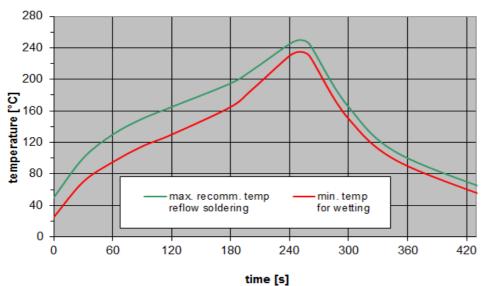


Figure 8: Recommended reflow profile for convection and infrared soldering – lead-free solder.



12 ESD protection of SAW filters

SAW filters are Electro Static Discharge sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies have to be applied.

In general, "ESD matching" has to be ensured at that filter port, where electrostatic discharge is expected.

Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore, only the input matching of the SAW filter has to be designed to short circuit or to block the ESD pulse.

Below four figures show recommended "ESD matching" topologies.

Depending on the input impedance of the SAW filter and the source impedance, the needed component values have to be determined from case to case.

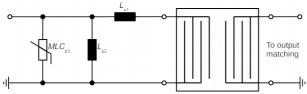


Figure 9: MLC varistor plus ESD matching.

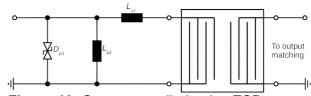


Figure 10: Suppressor diode plus ESD matching.

In cases where minor ESD occur, following simplified "ESD matching" topologies can be used alternatively.

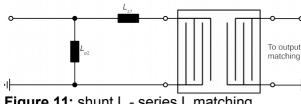
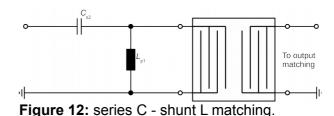


Figure 11: shunt L - series L matching.

standards or customer specific requirements.



Effectiveness of the applied ESD protection has to be checked according to relevant industry

For further information, please refer to RF360 Application report: "ESD protection for SAW filters". This report can be found under www.rf360jv.com/rke. Click on "Applications Notes".



13 Annotations

13.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

13.3 Shelf life

The shelf life of components is determined by solderability of the package terminals. It is specified as 2 years from manufacturing date assuming the following conditions:

- storage in original packaging and non-aggressive atmosphere,
- storage temperature ranging from -25 °C to +40 °C, and
- storage humidity with ≤ 75 % r.h. mean annual humidity, ≤ 95 % r.h. for max. 30 days / year, and no dew condensation.



14 Cautions and warnings

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14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.



15 Important notes

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